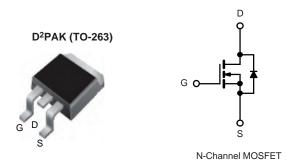


### N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a, c</sup>	Q <sub>g</sub> (Typ.)		
40	0.0017 at V <sub>GS</sub> = 10 V	150	120 nC		
	0.0025 at V <sub>GS</sub> = 4.5 V	135	120110		



#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $R_g$  and UIS Tested

#### **APPLICATIONS**

- Synchronous Rectification
- Power Supplies

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub>	± 25	v	
	T <sub>C</sub> = 25 °C		150 <sup>a, c</sup>	A	
Continuous Drain Current (T 175 °C)	T <sub>C</sub> = 70 °C		120 <sup>c</sup>		
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	29 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		23 <sup>b</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	380	-	
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	80		
Single Pulse Avalanche Energy	L = 0.1 MH	E <sub>AS</sub>	320	mJ	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	110 <sup>a, c</sup>	Α	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'S	2.6 <sup>b</sup>	A	
	T <sub>C</sub> = 25 °C		312 <sup>a</sup>	w	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P	200		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.13 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		2.0 <sup>b</sup>		
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.33	0.4	0/10	

Notes:

a. Based on  $T_C = 25 \ ^{\circ}C$ .

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.

<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	45			V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		41		- mV/°C		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η - 200 μΛ		- 8				
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0$ V, $V_{GS} = \pm 20$ V			± 100	nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 V, V_{GS} = 0 V$			1			
		$V_{DS}$ = 40 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10	μA		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS}$ = 10 V	120			А		
Drain-Source On-State Resistance <sup>a</sup>	Provide	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.0017		Ω		
	R <sub>DS(on)</sub>	$V_{GS}$ = 4.5 V, I <sub>D</sub> = 20 A		0.0025				
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A		180		S		
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			9000		pF		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		650				
Reverse Transfer Capacitance	C <sub>rss</sub>			450				
Total Gate Charge	Qg			120	180	nC		
Gate-Source Charge	Q <sub>gs</sub>	$V_{\rm DS}$ = 20 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 20 A		30				
Gate-Drain Charge	Q <sub>gd</sub>			16				
Gate Resistance	Rg	f = 1 MHz		0.85	1.3	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			20	30			
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		11	17	- - - ns -		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 20 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		77	115			
Fall Time	t <sub>f</sub>			10	15			
Turn-On Delay Time	t <sub>d(on)</sub>			102	155			
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		62	95			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 20$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		180	270			
Fall Time	t <sub>f</sub>			60	90			
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	$T_{C} = 25 \ ^{\circ}C$			110	A		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				200	~		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 20 A		0.8	1.2	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	75	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, Τ <sub>.I</sub> = 25 °C		70	105	nC		
Reverse Recovery Fall Time	t <sub>a</sub>	$r_F = 20$ A, $u/u_1 = 100$ A/µs, $r_J = 25$ °C		30				
verse Recovery Rise Time t <sub>b</sub>			20		ns			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

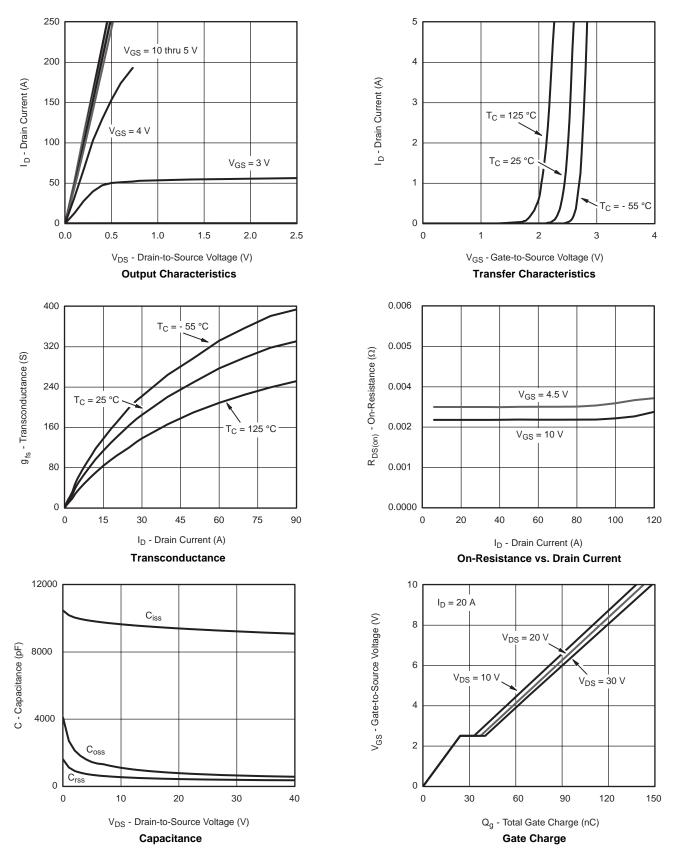
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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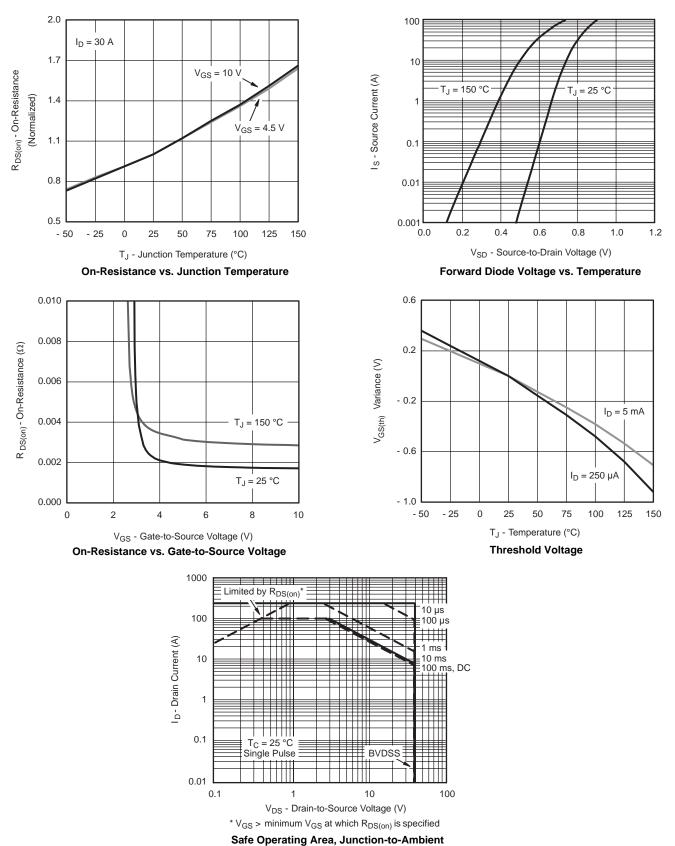
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



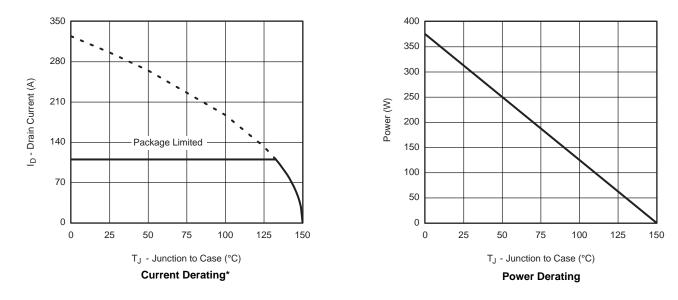
服务热线:400-655-8788



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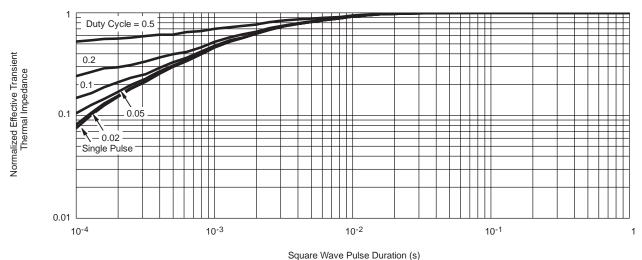






#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

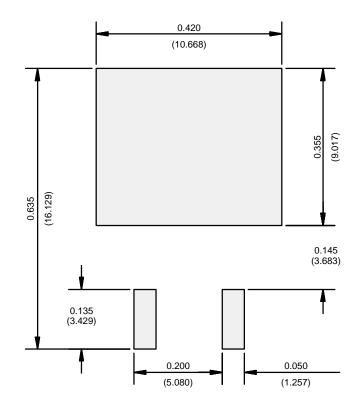
\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)



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